

New SPAD detector package for SLR and laser time transfer

Ivan Prochazka¹, Tereza Flekova¹, Jan Kodet^{1,2}, Josef Blazej¹

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¹ Czech Tech. University in Prague, Brehova 7, 115 19 Prague 1, Czech Republic

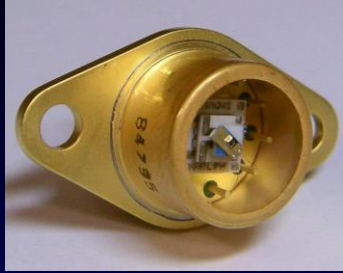
² Technische Universität München, Forschungseinrichtung Satellitengeodäsie, München, Germany

Outline

- Why new SPAD detector(s) ?
- Detector parameters requirements
- Detector design construction
- Key parameters
 - timing resolution
 - timing drift
 - dark count rate
 - single – multiple photon response
- Summary & Conclusion



Why new SPAD detector_(s) ?



- # 1
The supply of TE3 cooled 200um diameter chips is approaching zero ☹️
- #2
New applications , namely Laser Time Transfer require extremely high timing stability ~ 100 fs
- #3
New wavelengths (1064nm, 1540 nm,...)
see our poster

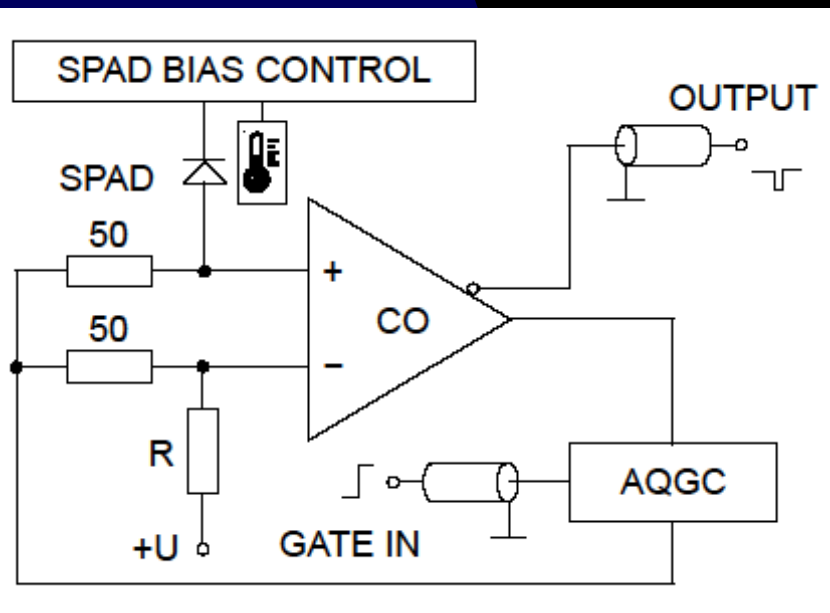
New SPAD detector package



□ K14 SPAD chips 100um diameter

□ AVAILABLE

□ TE1 cooling, NO temperature sensor (!!)



□ New active quenching and gating circuit
Analogy to ELT+ space segment

□ Very simple, compact, space qualified

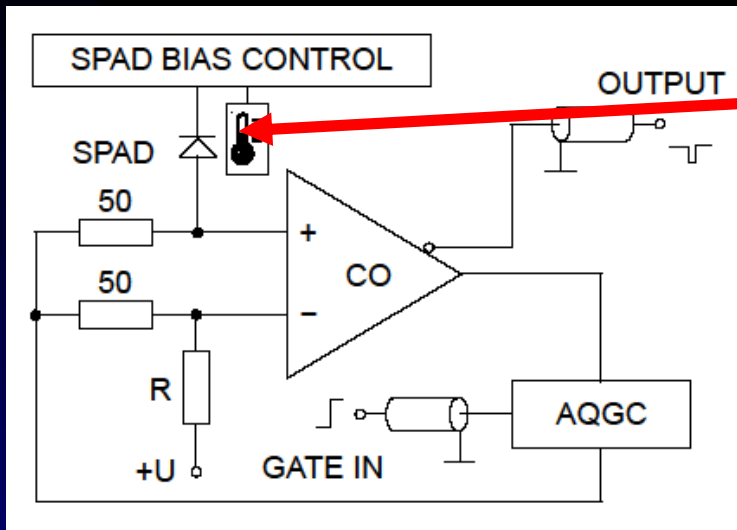
□ SPAD max 2.5 Volts above ☹

□ Optimized for high temperature stability

Rev. of Sci. Instruments 87, 056102 (2016);

New SPAD detector package

Passive compensation of temperature delay dependence

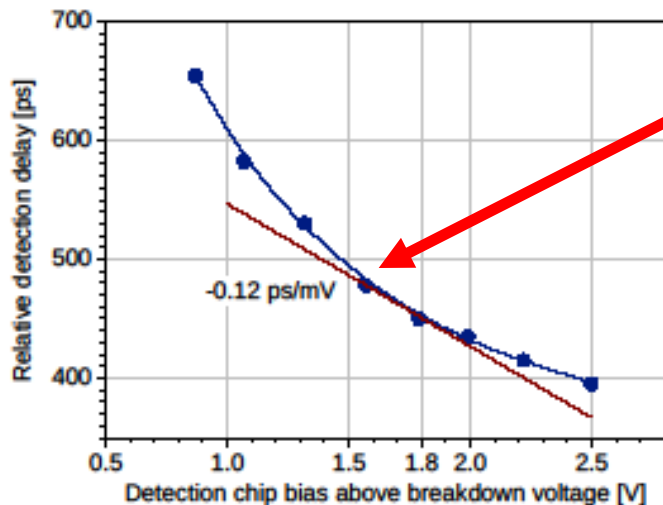


□ Built in SPAD bias control circuit is adjusting bias above break versus temp. and also tunes detection delay

□ Key components (SPAD, comparator) positive temperature coefficient ~ 1 ps/K

□ SPAD chip detection delay vers. bias coefficient is negative -0.12 ps / mV

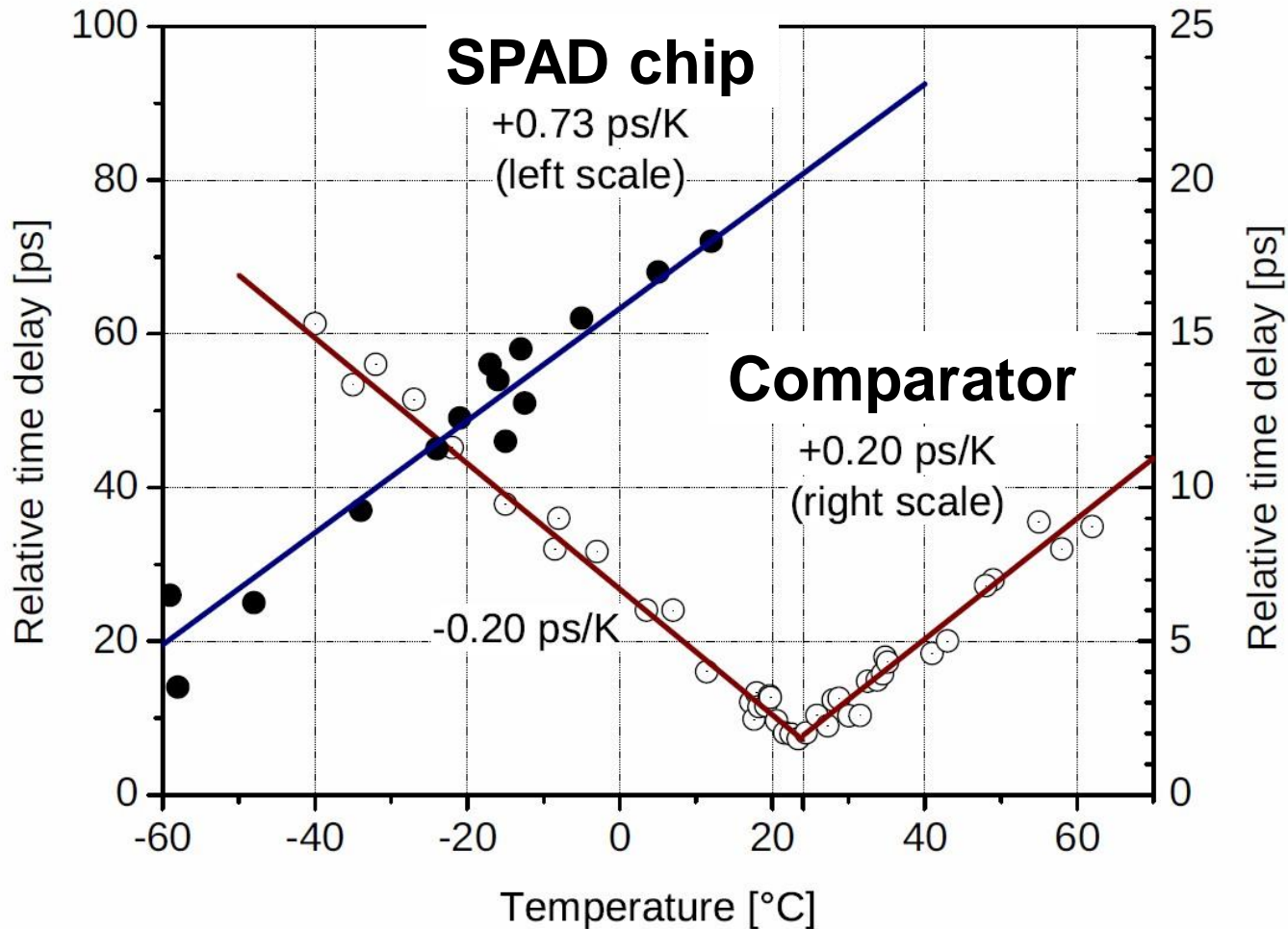
□ SPAD bias control may compensate all the (smooth !) temperature contributors.



Rev. of Sci. Instruments **89**, 056106 (2018)

New SPAD detector package

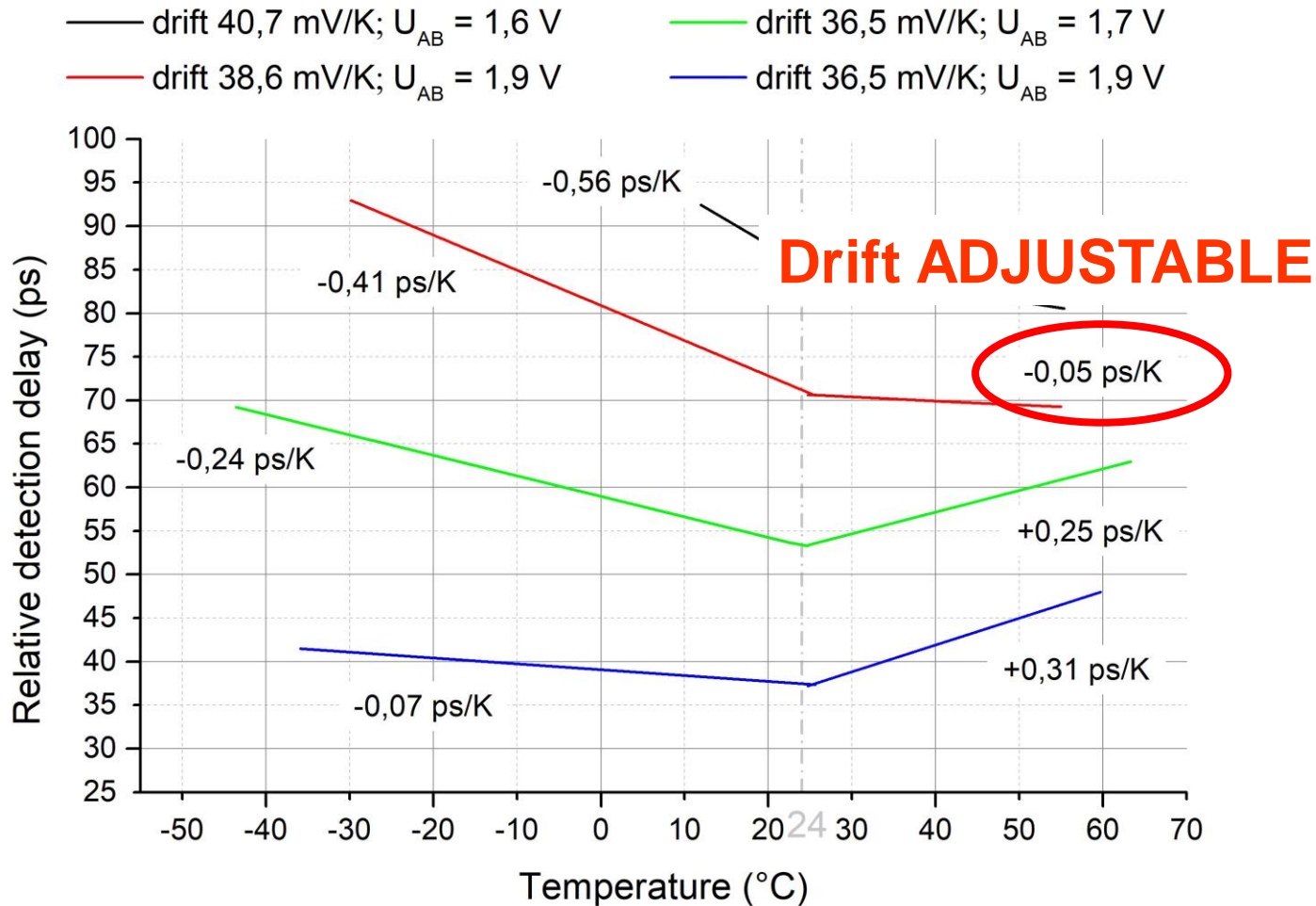
Passive compensation of temperature delay dependence



New SPAD detector package

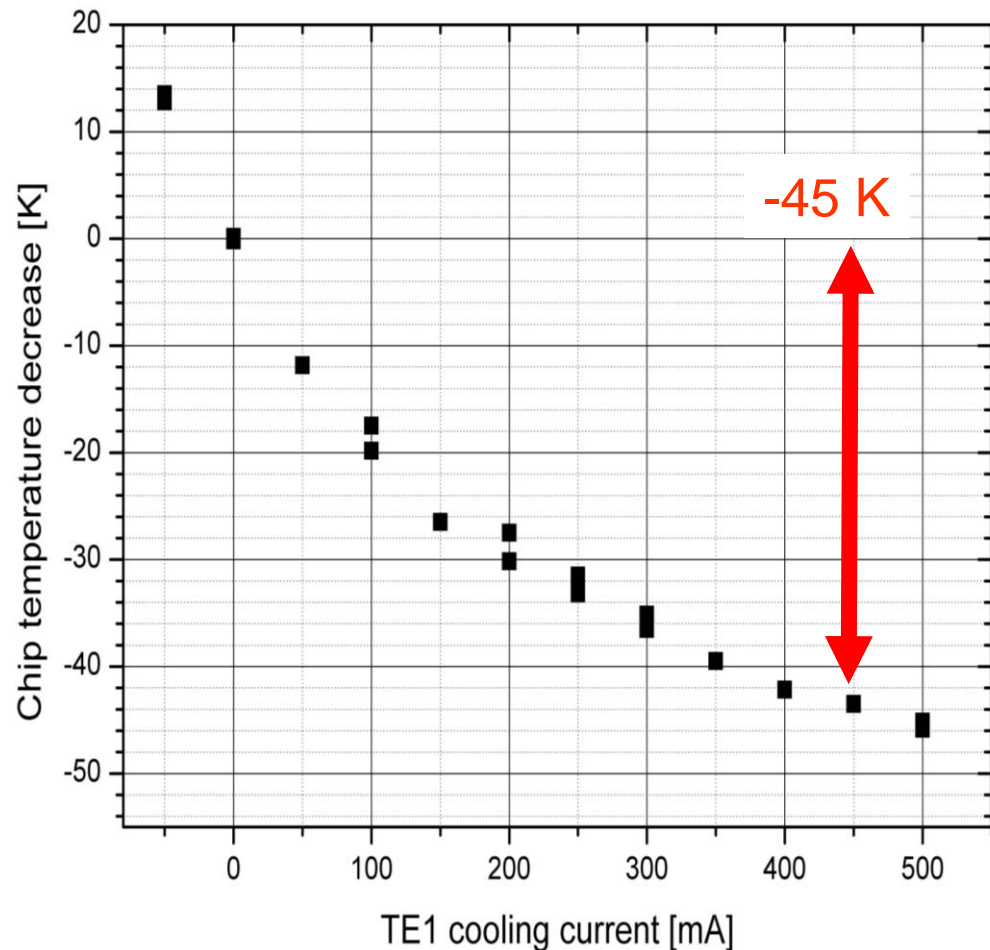
Passive compensation of temperature delay dependence

SPAD Detection delay



Thermoelectric cooling TE1 of SPAD chip

PROBLEM – No temperature sensor inside



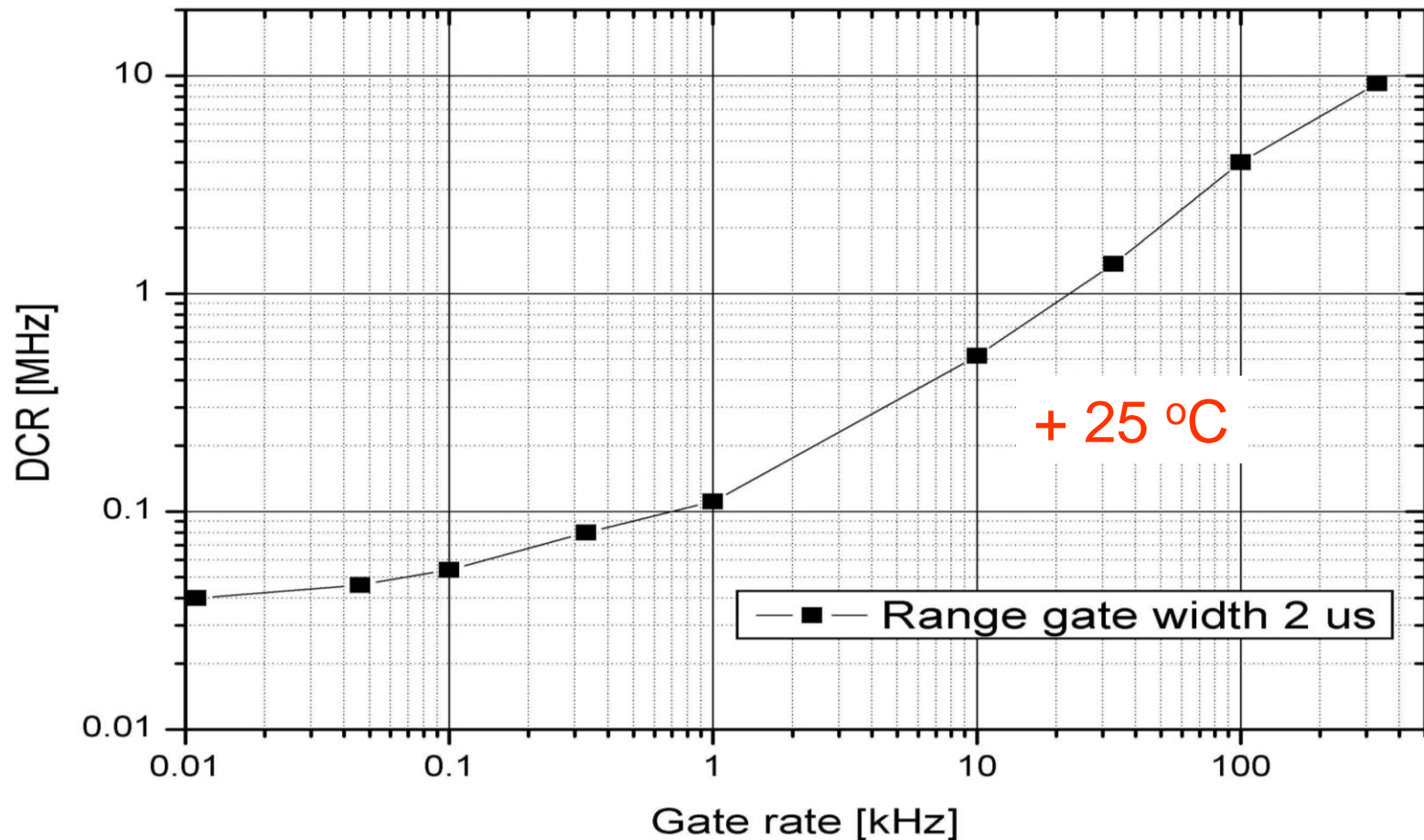
- No chance to stabilize the chip temperature
- Stabilize the cooling current
=> fixed temperature step
- Compensate the detection delay of the entire device by its body temperature (hot side of TE1)
- It works (!)
Delay stability is OK
- BUT the detector is more noisy in summer time ☺



Thermoelectric cooling TE1 of SPAD chip

Dark count rate

Effective dark count rate TE1 SPAD 100um 2V ab

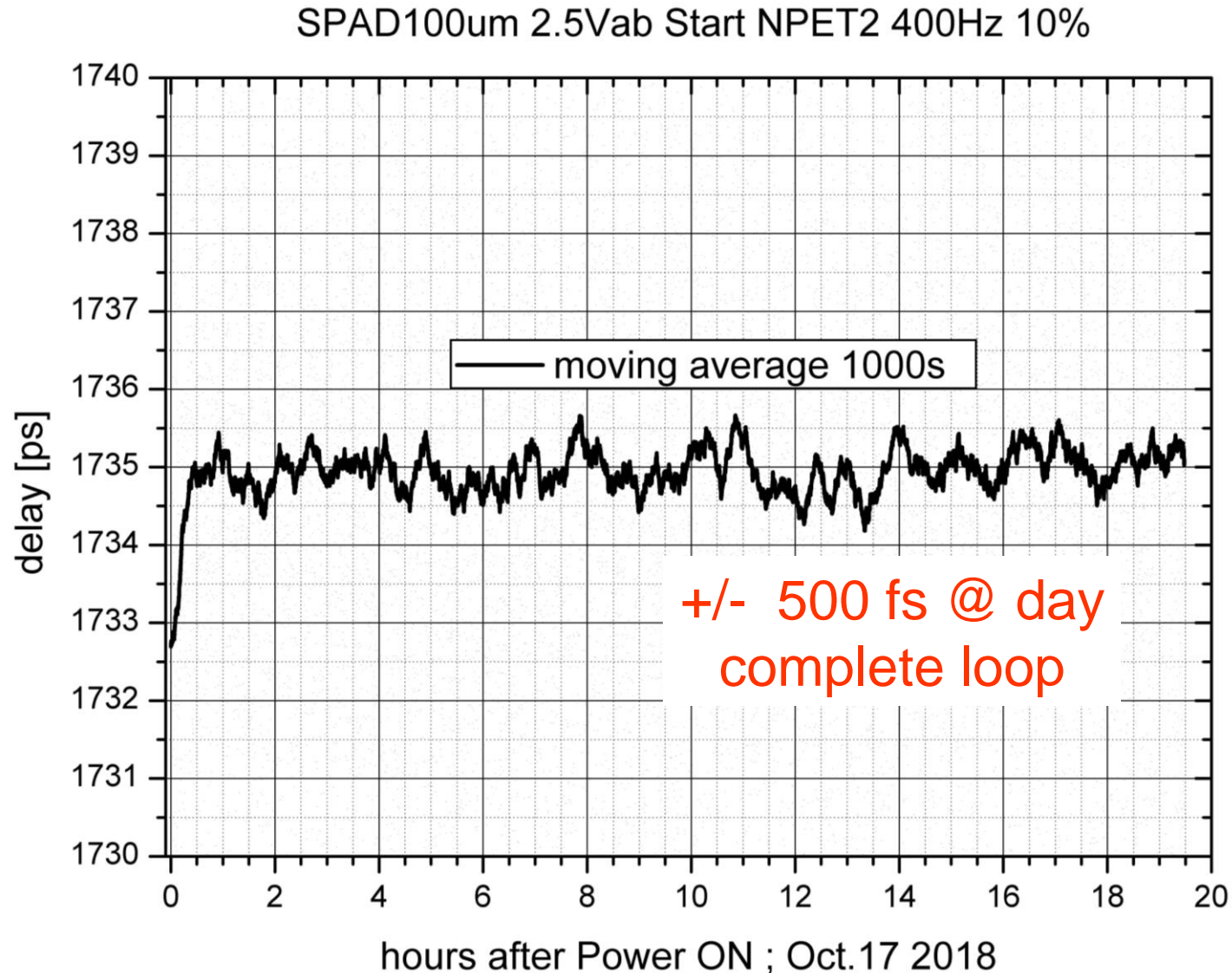


- New gating logic, Terminate the windows
- Worst case estimate, rather noisy test chip



Passive compensation of temperature delay dependence

Detection delay stability TE1



Passive compensation of temperature delay dependence

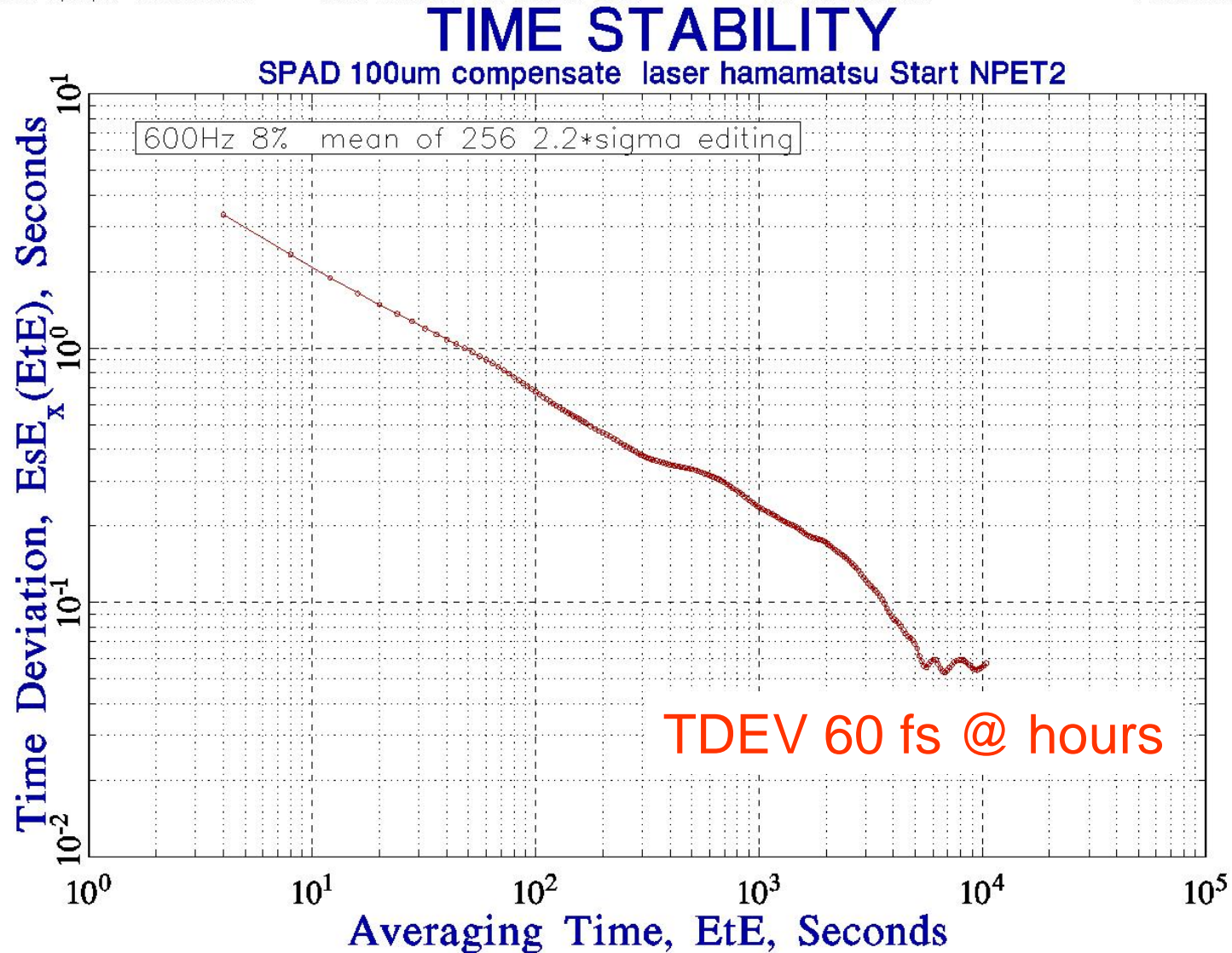
Detection delay stability TE1

Date: 11/02/18 Time: 10:00:51

Data Points 2500 thru 13000 of 16663

Tau=4.0000000e+00

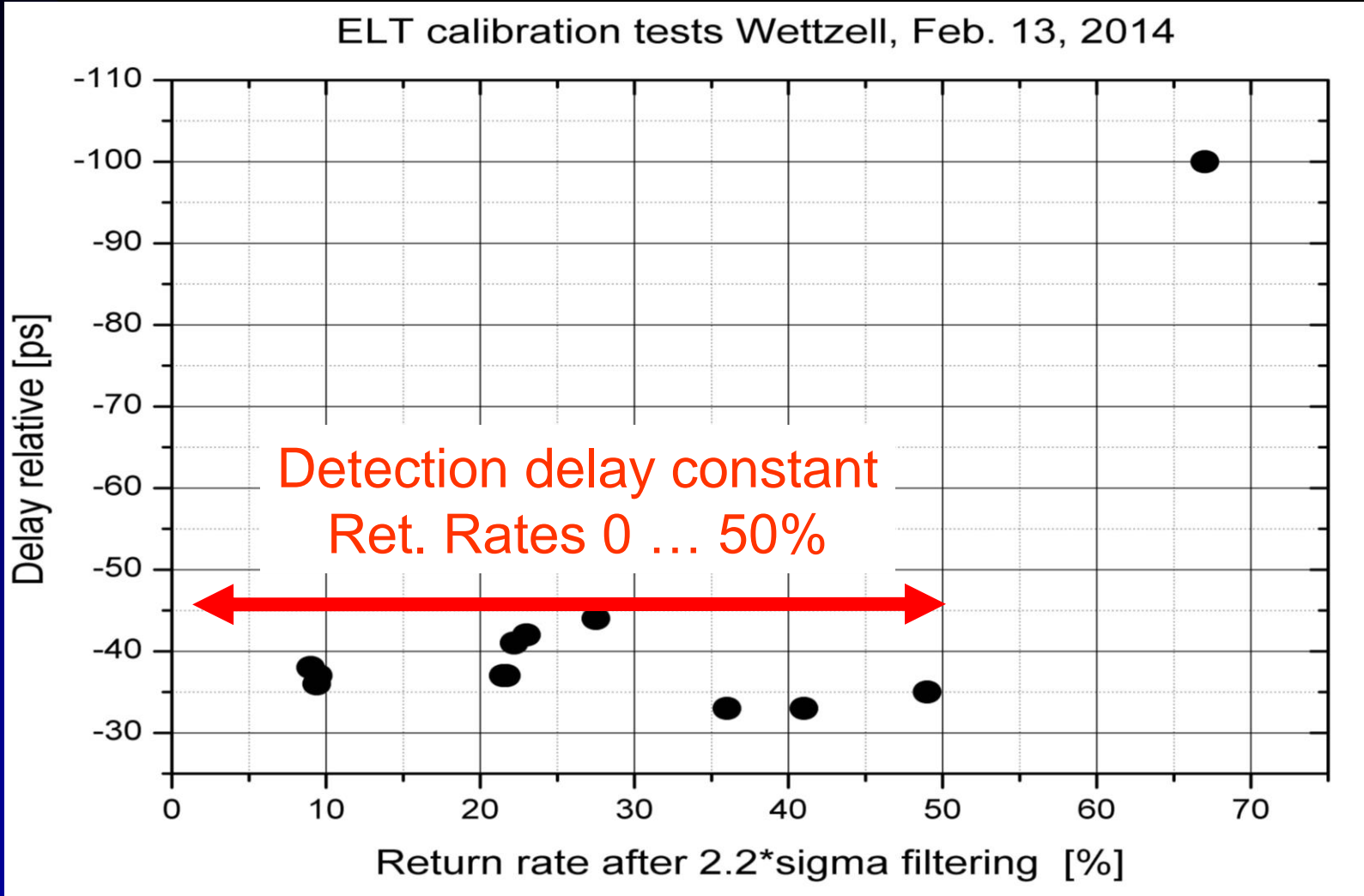
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Slide 17

Passive compensation of temperature delay dependence Response to multiphoton echoes

C-SPAD operation of 100um chip is difficult



Passive compensation of temperature delay dependence New SPAD detector package 100um TE1



- Standard SPAD housing, compact power supply
- New aspheric lens collecting optics, 12 mm diam.beam
- Standard Gate and output signals
- 1 : 1 replaceable with C-SPAD and/or HQE SPAD pack.

SUMMARY

New SPAD detector package 100um TE1
Passive compensation of temperature delay dependence

- Detector package for SLR and laser time transfer optimized for high detection delay stability

- PARAMETERS

- Active area 100 um diameter
- Photon det. Effi. > 35 % @ 532 nm
- Jitter < 18 ps rms
- Temp.drift tunable, abs.< 250 fs /K
- Stability < 100 fs @ hours

- Few photons / echo data rate up to 50% are acceptable for ideal targets and LTT

- Thanks for your attention